

AMENDMENTS TO THE CLAIMS

1-11. (Cancelled)

12.(Currently Amended) A method for preventing elution of nickel from a water-contact instrument made of copper alloy and plated with a material containing nickel, which comprises applying a protective film formation agent which comprises a protective film formation component consisting essentially of ~~benzotriazole~~ a benzotriazole having a hydrophilic group and a straight-chain fatty acid, and an organic solvent for dissolving the component in water, to a surface of a nickel coat that wraps around and adheres to at least a water-contact surface of the water-contact instrument to form a protective film; and drying to intimately bond the protective film to the surface of the nickel coat; wherein the protective film consists essentially of the benzotriazole having a water-repellent outside and an inside having ~~a~~ said hydrophilic group bonded intimately to the nickel coat and the straight-chain fatty acid having an inside having a hydrophilic group bonded intimately to the nickel coat, thereby suppressing elution of nickel with the protective film.

13.(Cancelled)

14.(Previously Presented) The method for preventing elution of nickel from a water-contact instrument made of copper alloy according to claim 12, further comprising forming a second protective film on a surface of said nickel coat at a water-contact section of the water-contact instrument using the protective film formation agent, thereby suppressing the elution of the nickel due to bimetallic corrosion via the second protective film.

15.(Previously Presented) The method for preventing elution of nickel from a water-contact instrument made of copper alloy according to claim 14, wherein the nickel coat has pinholes and a second protective film is formed in the pinholes using the protective film formation agent so that the copper alloy and nickel are insulated.

16.(Previously Presented) The method for preventing elution of nickel from a water-contact instrument made of copper alloy according to claim 12, wherein the protective film formation agent is used to form the protective film on a surface of a nickel coat on a water-contact section of the water-contact instrument, thereby suppressing via the protective film dissolution of the nickel by wetting.

17.(Previously Presented) The method for preventing elution of nickel from a water-contact instrument made of copper alloy according to claim 12, further comprising removing by rinsing a nickel salt adhering as a residual to an inside of the water-contact instrument and applying the protective film formation agent to at least the water-contact surface of the water-contact instrument to form a protective film.

18.(Previously Presented) The method for preventing elution of nickel from a wetted instrument made of copper alloy according to claim 17 and including lead, further comprising deleading a surface layer of the wetted section of the wetted instrument.

19.(Previously Presented) The method for preventing elution of nickel from a water-contact instrument made of copper alloy according to claim 18, wherein both the nickel salt adhering as the residual to the inside of the water-contact instrument and lead segregated on a surface layer of a water-contact section of the water-contact instrument are rinsed with a cleaning fluid containing a nitric acid and having a hydrochloric acid added thereto as an inhibitor.

20.(Cancel)